

AMP-LATCH | AMP-LATCH Universal Headers

TE Internal #: 5499206-9

Ribbon Cable Connectors, Wire-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Vertical, Through Hole - Solder, 2 Row, AMP-LATCH

Universal Headers

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Connector System: Wire-to-Board

Number of Positions: 40

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

All AMP-LATCH UNIVERSAL HEADERS (525)

Features

Product Type Features

Ribbon Cable Connector Header Type	Universal Ejection Pin Headers
Connector Mating Latch & Lock Type	Long
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	40
PCB Mount Orientation	Vertical
Number of Rows	2

Electrical Characteristics

Insulation Resistance	5000 MΩ
insulation Nesistance	2000 14125



Primary Product Color Connector Profile Connector Profile Contact Features Mating Square Post Dimension PCB Contact Termination Area Plating Material Thickness Contact Type Prin Contact Mating Area Plating Material Thickness PCB Contact Termination Area Plating Material Thickness PCB Contact Mating Area Plating Material Linkness PCB Contact Mating Area Plating Material Contact Mating Area Plating Material PCB Contact Termination Area Plating Material Phosphor Bronze PCB Contact Termination Post & Tail Diameter PCB Mound Termination Post & Tail Diameter PCB Mount Alignment Without Panel Mount Alignment Without Panel Mount Alignment Without PCB Mount Alignment Type PCB Mount Recention Without PCB Mount Recention Wit		
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Mating Square Post Dimension	Primary Product Color	Black
Mating Square Post Dimension PCB Contact Termination Area Plating Material Thickness Contact Type Pin Contact Type Pin Contact Mating Area Plating Material Contact Shape & Form Square PCB Contact Termination Area Plating Material Tin Contact Base Material Phosphor Bronze Contact Gurrent Rating (Max) 1 A Termination Features Round Termination Post & Tail Diameter After Mating Area Plating Material After Mating Area Plating Material After Mating Alignment PCB Mount Alignment Without PCB Mount Alignment Type Center, Dual Polarizing Bar Mating Retention Mating Retention Mating Retention Mating Retention Type Connector Mounting Type Board Mount Housing Features Housing Material Centerline (Pitch) Dimensions	Connector Profile	Standard
PCB Contact Termination Area Plating Material Thickness 2.54 µm[100 µin] Contact Mating Area Plating Material Thickness 7.6 µm[30 µin] Contact Mating Area Plating Material Gold Contact Mating Area Plating Material Gold Contact Shape & Form 5quare PCB Contact Termination Area Plating Material Tin Contact Base Material Phosphor Bronze Contact Gurrent Rating (Max) 1A Termination Features Round Termination Post & Tail Diameter 4.44 mm[025 in] Termination Post & Tail Length 2.79 mm[.11 in] Termination Method to Printed Circuit Board Through Hole - Solder Wechanical Attachment Mating Alignment Without PCB Mount Alignment Without PCB Mount Retention Without PCB Mount Retention Without Mating Retention With Mating Retention With Mating Retention Type Ejection Latch Connector Mounting Type Board Mount Housing Features Housing Material Glass Filled Nylon/Polyester Center[ine (Pitch) 2.54 mm[.1 in] Dimensions	Contact Features	
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Contact Base Material Phosphor Bronze Contact Current Rating (Max) 1 A Termination Features Round Termination Post & Tail Diameter	Contact Shape & Form	Square
Contact Current Rating (Max) Termination Features Round Termination Post & Tail Diameter .64 mm[.025 in] Termination Post & Tail Length .2.79 mm[.11 in] Termination Method to Printed Circuit Board .Through Hole - Solder Mechanical Attachment Mating Alignment .Without Panel Mount Feature .Without PCB Mount Retention .Without Mating Alignment Type .Center, Dual Polarizing Bar Mating Retention Type .Ejection Latch Connector Mounting Type .Board Mount Housing Features Housing Material .Glass Filled Nylon/Polyester Centerline (Pitch) .2.54 mm[.1 in]	PCB Contact Termination Area Plating Material	Tin
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Round Termination Post & Tail Diameter	Contact Current Rating (Max)	1 A
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PCB Mount Alignment Panel Mount Feature Without PCB Mount Retention Without Mating Alignment Type Center, Dual Polarizing Bar Mating Retention With Mating Retention Type Ejection Latch Connector Mounting Type Board Mount Housing Features Housing Material Centerline (Pitch) Dimensions Without Glass Filled Nylon/Polyester 2.54 mm[.1 in]	Mechanical Attachment	
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Mating Retention With Mating Retention Type Ejection Latch Connector Mounting Type Board Mount Housing Features Housing Material Glass Filled Nylon/Polyester Centerline (Pitch) 2.54 mm[.1 in]	PCB Mount Retention	Without
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Housing Features Housing Material Centerline (Pitch) Cimensions Glass Filled Nylon/Polyester 2.54 mm[.1 in]	Mating Retention Type	Ejection Latch
Housing Material Centerline (Pitch) Cimensions Glass Filled Nylon/Polyester 2.54 mm[.1 in]	Connector Mounting Type	Board Mount
Centerline (Pitch) 2.54 mm[.1 in] Dimensions	Housing Features	
Dimensions	Housing Material	Glass Filled Nylon/Polyester
	Centerline (Pitch)	2.54 mm[.1 in]
Shrouded End Dimension 3.81 mm[.15 in]	Dimensions	
	Shrouded End Dimension	3.81 mm[.15 in]



Connector Length	70.1 mm[2.76 in]
Connector Height	13.94 mm[.548 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	

Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

Operation/Application

Circuit Application	Signal	
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Industry Standards

UL Flammability Rating	UL 94V-0	

Packaging Features

Packaging Quantity	18
Packaging Method	Tray

Other

Wire-to-Board Connector Comment Mates with Receptacles
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products



will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts













Female Socket Connectors: Strain

Relief









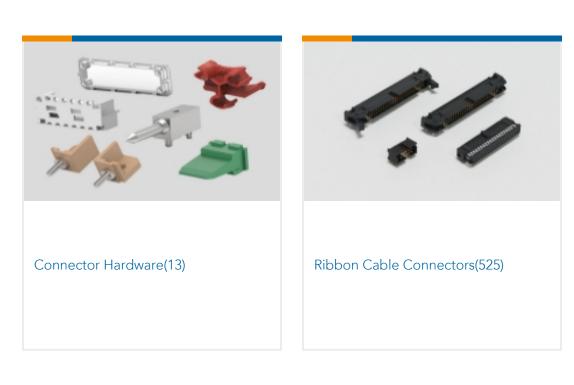






Also in the Series | AMP-LATCH Universal Headers





Customers Also Bought















Documents

Product Drawings

A/L UNIV HDR 40P VERT LG LAT

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5499206-9_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5499206-9_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5499206-9_C.3d_stp.zip

English

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Datasheets & Catalog Pages

Ribbon Cable Interconnect Solutions

English

Product Specifications

Product Specification

English

Product Environmental Compliance

MD_5499206-9_03162017039_dmtec

English

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